



# PMEG060V100EPE-Q

60 V, 10 A low VF Schottky barrier rectifier

15 July 2022

Product data sheet

## 1. General description

Planar Low  $V_F$  Schottky barrier rectifier encapsulated in a CFP15B (SOT1289B) power and flat lead Surface-Mounted Device (SMD) plastic package.

## 2. Features and benefits

- Very low forward voltage
- High power capability due to clip-bonding technology
- Small and thin SMD plastic package
- Qualified according to AEC-Q101 and recommended for use in automotive applications

## 3. Applications

- High efficiency DC-to-DC conversion
- Low voltage rectification
- Switch mode power supply
- Freewheeling application
- Reverse polarity protection
- OR-ing

## 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$I_{F(AV)}$	average forward current	$\delta = 0.5$ ; $f = 20$ kHz; square wave; $T_{sp} \leq 174$ °C	-	-	10	A
$V_R$	reverse voltage	$T_j = 25$ °C	-	-	60	V
$V_F$	forward voltage	$I_F = 10$ A; pulsed; $T_j = 25$ °C	[1]	500	560	mV
$I_R$	reverse current	$V_R = 60$ V; pulsed; $T_j = 25$ °C	[1]	150	700	$\mu$ A

[1] Very short pulse, in order to maintain a stable junction temperature.

## 5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	A	anode	<p>CFP15B (SOT1289B)</p>	<p>aaa-009063</p>
2	A	anode		
3	K	cathode		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PMEG060V100EPE-Q	CFP15B	plastic, thermal enhanced ultra thin SMD package; 3 leads; 2.13 mm pitch; 5.8 x 4.3 x 0.95 mm body	<a href="#">SOT1289B</a>

7. Marking

Table 4. Marking codes

Type number	Marking code
PMEG060V100EPE-Q	060V 100E

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
$V_R$	reverse voltage	$T_j = 25\text{ }^{\circ}\text{C}$		-	60	V
$I_F$	forward current	$\delta = 1; T_{sp} \leq 173\text{ }^{\circ}\text{C}$		-	14	A
$I_{F(AV)}$	average forward current	$\delta = 0.5; f = 20\text{ kHz; square wave; } T_{sp} \leq 174\text{ }^{\circ}\text{C}$		-	10	A
$I_{FSM}$	non-repetitive peak forward current	half sine-wave pulse; $t_p = 8.3\text{ ms; } T_{j(init)} = 25\text{ }^{\circ}\text{C}$		-	280	A
$P_{tot}$	total power dissipation	$T_{amb} \leq 25\text{ }^{\circ}\text{C}$	<a href="#">[1]</a>	-	1.66	W
			<a href="#">[2]</a>	-	2.15	W
$T_j$	junction temperature			-	175	$^{\circ}\text{C}$
$T_{amb}$	ambient temperature			-55	175	$^{\circ}\text{C}$
$T_{stg}$	storage temperature			-65	175	$^{\circ}\text{C}$

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.  
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1] [2]	-	-	90	K/W
			[1] [3]	-	-	70	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point		[4]	-	-	3	K/W

- [1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses  $P_R$  are a significant part of the total power losses.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.
- [4] Soldering point of cathode tab.

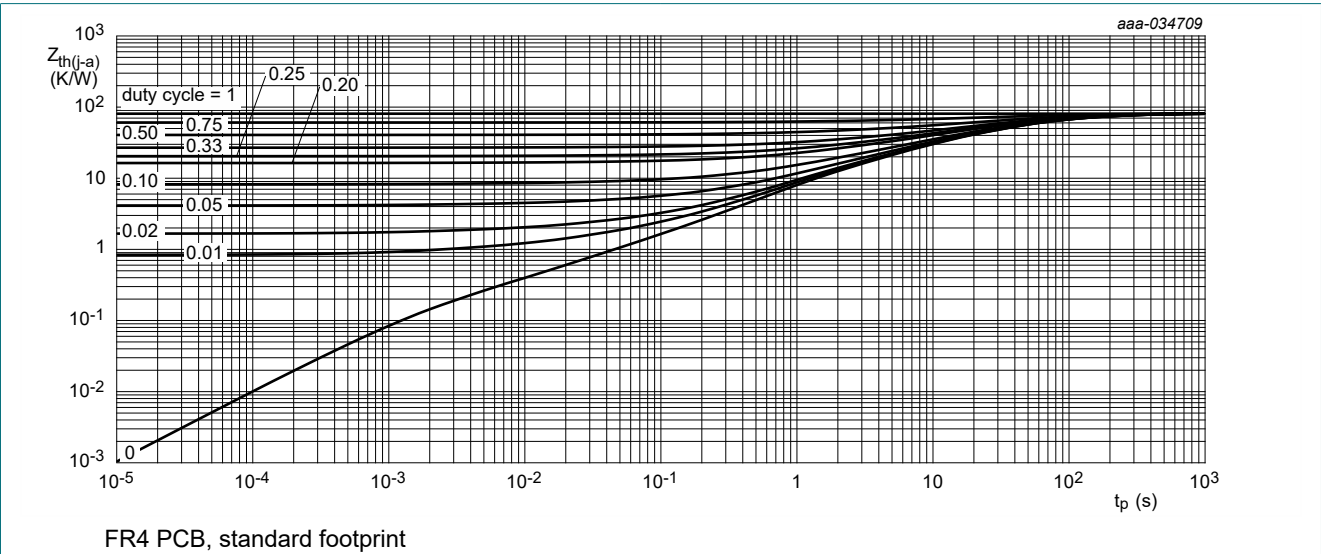


Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

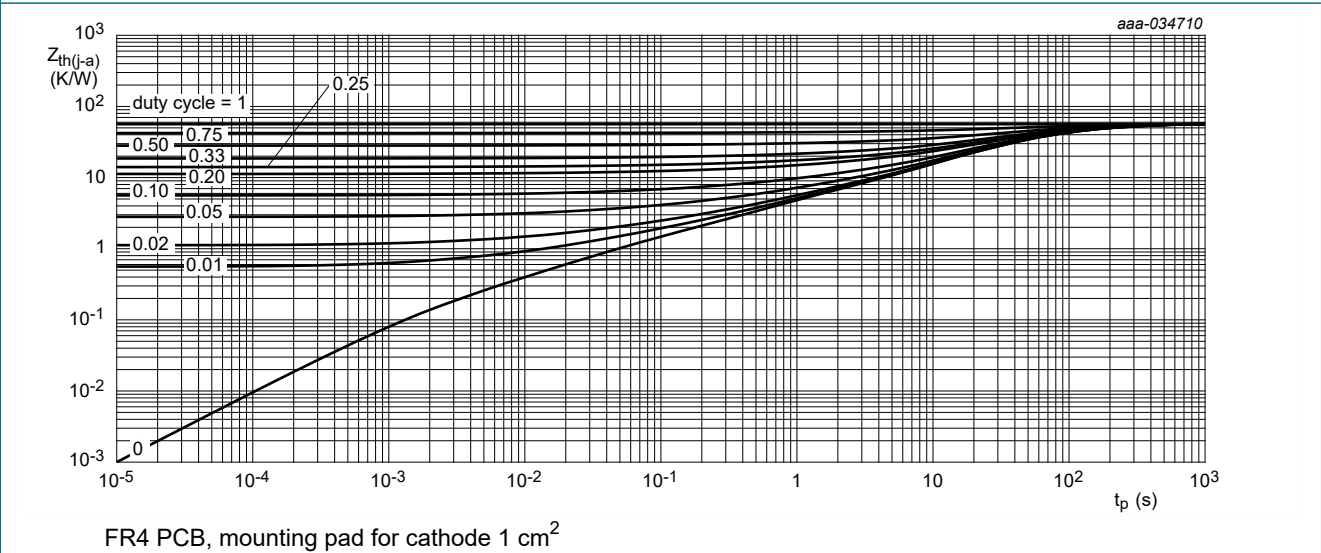


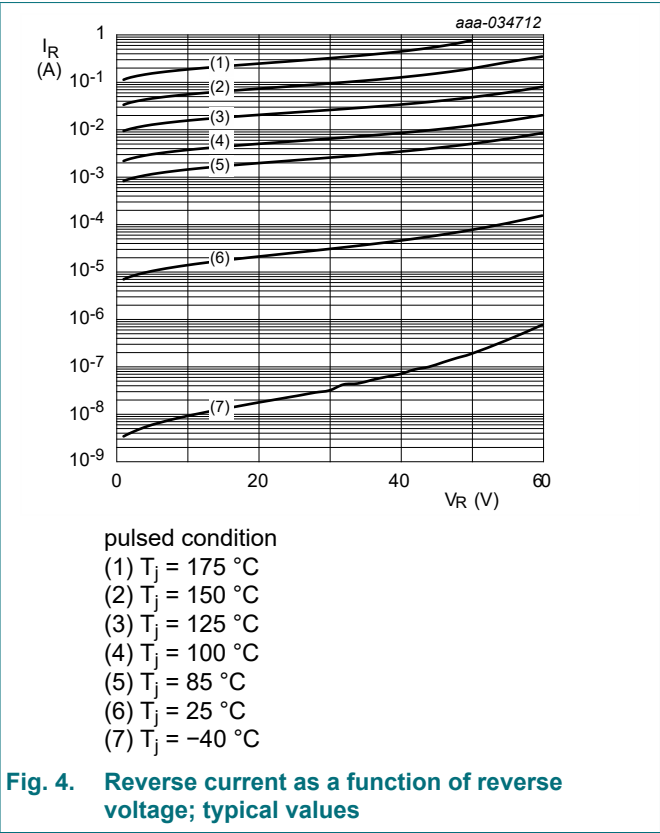
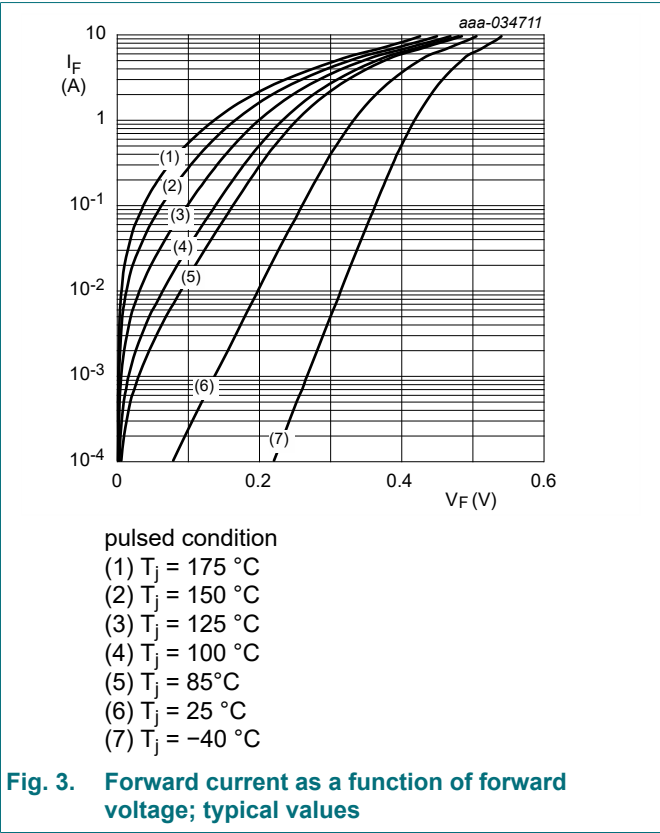
Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

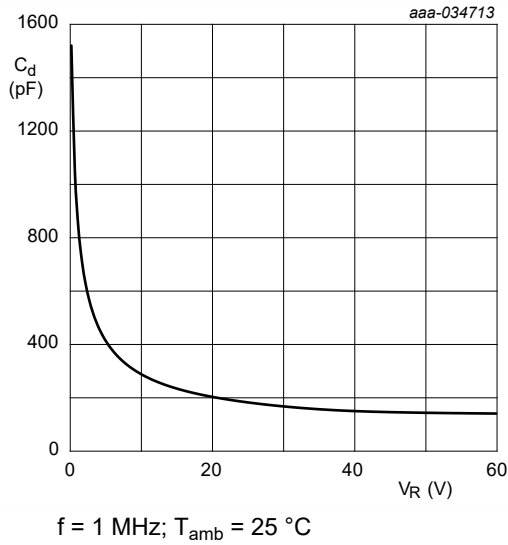
10. Characteristics

Table 7. Characteristics

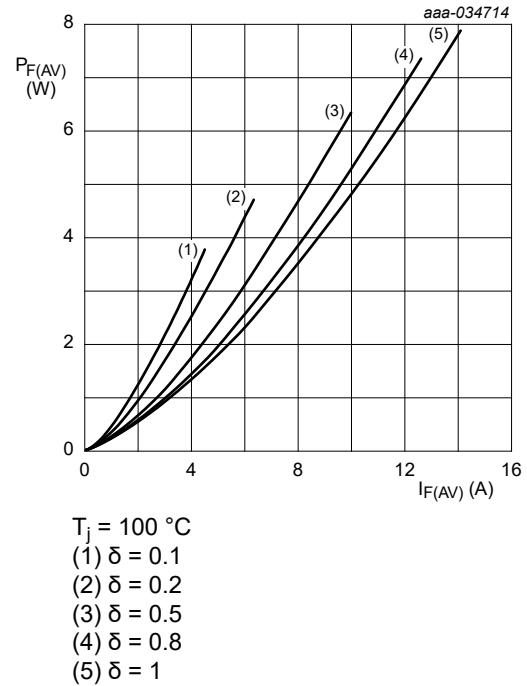
Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$V_{(BR)R}$	reverse breakdown voltage	$I_R = 5\text{ mA}$ ; $T_j = 25\text{ }^{\circ}\text{C}$		60	-	-	V
$V_F$	forward voltage	$I_F = 1\text{ A}$ ; pulsed; $T_j = 25\text{ }^{\circ}\text{C}$	[1]	-	325	370	mV
		$I_F = 5\text{ A}$ ; pulsed; $T_j = 25\text{ }^{\circ}\text{C}$	[1]	-	420	470	mV
		$I_F = 10\text{ A}$ ; pulsed; $T_j = 25\text{ }^{\circ}\text{C}$	[1]	-	500	560	mV
		$I_F = 10\text{ A}$ ; pulsed; $T_j = -40\text{ }^{\circ}\text{C}$	[1]	-	540	620	mV
		$I_F = 10\text{ A}$ ; pulsed; $T_j = 125\text{ }^{\circ}\text{C}$	[1]	-	460	540	mV
$I_R$	reverse current	$V_R = 60\text{ V}$ ; pulsed; $T_j = 25\text{ }^{\circ}\text{C}$	[1]	-	150	700	$\mu\text{A}$
$C_d$	diode capacitance	$V_R = 1\text{ V}$ ; $f = 1\text{ MHz}$ ; $T_j = 25\text{ }^{\circ}\text{C}$		-	833	-	pF
		$V_R = 10\text{ V}$ ; $f = 1\text{ MHz}$ ; $T_j = 25\text{ }^{\circ}\text{C}$		-	283	-	pF
$t_{rr}$	reverse recovery time	$I_F = 0.5\text{ A}$ ; $I_R = 0.5\text{ A}$ ; $I_{R(\text{meas})} = 0.1\text{ A}$ ; $T_j = 25\text{ }^{\circ}\text{C}$		-	27	-	ns
	reverse recovery time ramp recovery	$dI_F/dt = 100\text{ A}/\mu\text{s}$ ; $I_F = 3\text{ A}$ ; $V_R = 30\text{ V}$ ; $T_j = 25\text{ }^{\circ}\text{C}$		-	17	-	ns
$V_{FRM}$	peak forward recovery voltage	$I_F = 0.5\text{ A}$ ; $dI_F/dt = 20\text{ A}/\mu\text{s}$ ; $T_j = 25\text{ }^{\circ}\text{C}$		-	310	-	mV

[1] Very short pulse, in order to maintain a stable junction temperature.

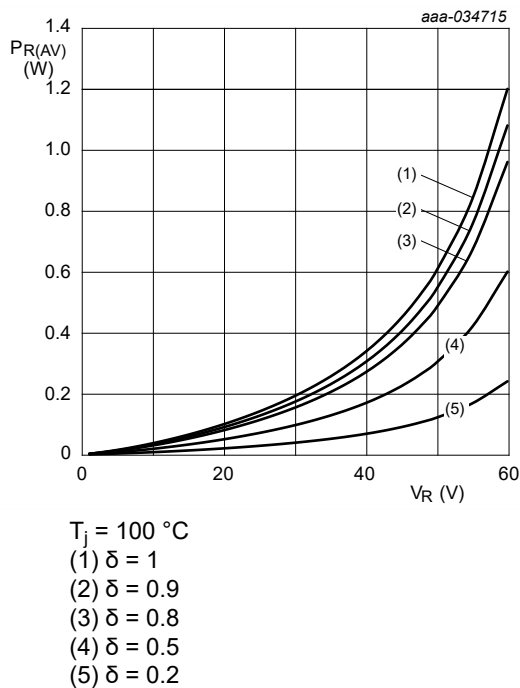




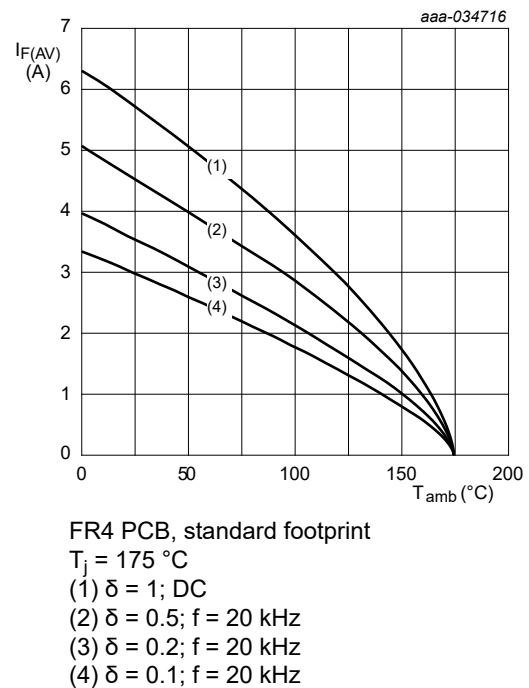
**Fig. 5.** Diode capacitance as a function of reverse voltage; typical values



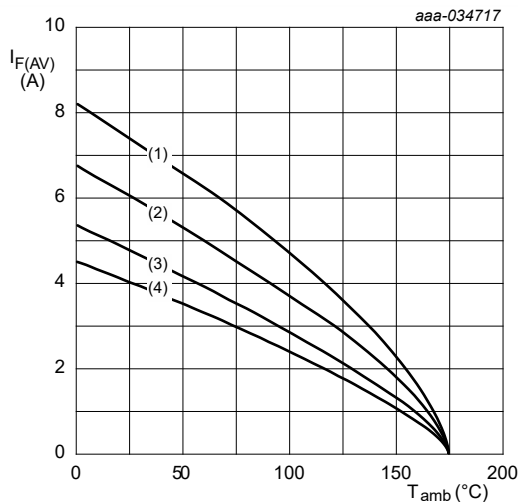
**Fig. 6.** Average forward power dissipation as a function of average forward current; typical values



**Fig. 7.** Average reverse power dissipation as a function of reverse voltage; typical values

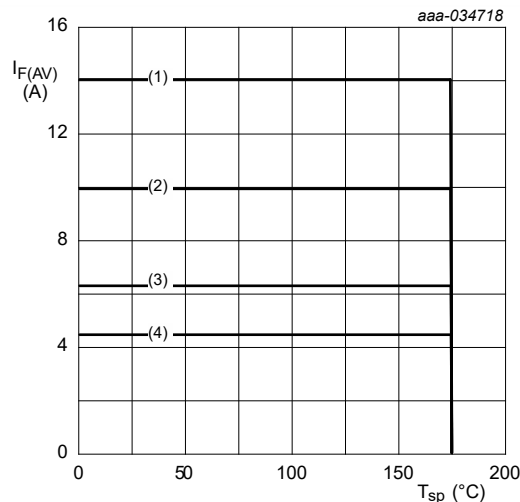


**Fig. 8.** Average forward current as a function of ambient temperature; typical values



FR4 PCB, mounting pad for cathode 1 cm<sup>2</sup>  
 $T_j = 175$  °C  
(1)  $\delta = 1$ ; DC  
(2)  $\delta = 0.5$ ;  $f = 20$  kHz  
(3)  $\delta = 0.2$ ;  $f = 20$  kHz  
(4)  $\delta = 0.1$ ;  $f = 20$  kHz

Fig. 9. Average forward current as a function of ambient temperature; typical values



$T_j = 175$  °C  
(1)  $\delta = 1$ ; DC  
(2)  $\delta = 0.5$ ;  $f = 20$  kHz  
(3)  $\delta = 0.2$ ;  $f = 20$  kHz  
(4)  $\delta = 0.1$ ;  $f = 20$  kHz

Fig. 10. Average forward current as a function of solder point temperature; typical values

11. Test information

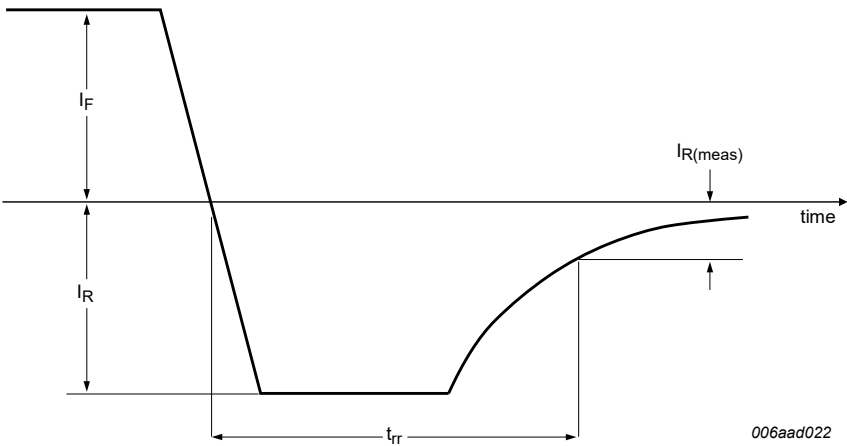


Fig. 11. Reverse recovery definition; step recovery

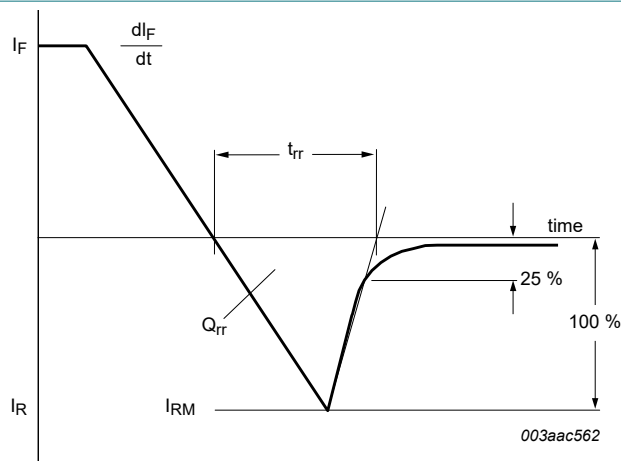


Fig. 12. Reverse recovery definition; ramp recovery

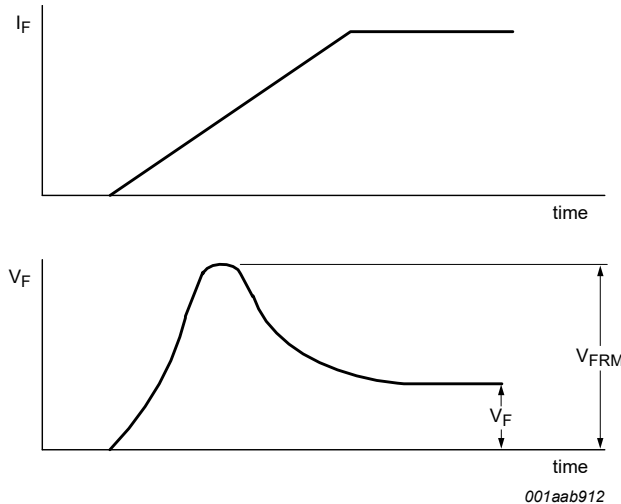


Fig. 13. Forward recovery definition

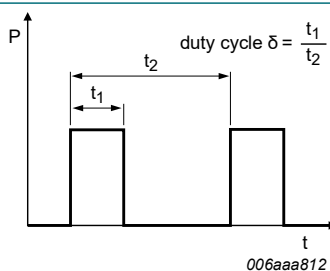


Fig. 14. Duty cycle definition

The current ratings for the typical waveforms are calculated according to the equations:

$$I_{F(AV)} = I_M \times \delta \text{ with } I_M \text{ defined as peak current}$$

$$I_{RMS} = I_{F(AV)} \text{ at DC, and } I_{RMS} = I_M \times \sqrt{\delta}$$

with  $I_{RMS}$  defined as RMS current.

### Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.





14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PMEG060V100EPE-Q v.1	20220715	Product data sheet	-	-

## 15. Legal information

### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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